

Electrical and magnetic properties of atomic layer deposited cobalt oxide and zirconium oxide nanolaminates

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Abstract

Introduction

Nanostructured Co_3O_4 in thin film form may possess and demonstrate a variety of properties making the material attractive for several applications. Co_3O_4 has been investigated as an important electrode material [1-4], gas sensor [5, 6], catalyst [7, 8], or superhydrophobic coating [9].

Co_3O_4 films have demonstrated resistive switching properties potentially enabling their application in resistive random access memory devices [10, 11].

Cobalt oxide, Co_3O_4 , containing Co^{2+} and Co^{3+} ions, is recognized as magnetic semiconductor material [12]. Antiferromagnetic behavior with characteristic magnetization-field curves can be demonstrated by Co_3O_4 nanoparticles [13]. Regarding the possible applications in spintronics, it may occur necessary to activate ferromagnetic coupling in Co_3O_4 nanoparticles by hybridization with foreign materials, e.g. graphene oxide [14].

Co_3O_4 films have been grown by oxidation of electron-beam evaporated Co layers [15], pulsed laser deposition [5, 10] chemical bath deposition [1, 6], chemical solution deposition [8, 11], hydrothermal method [2, 13], solvothermal synthesis [9], spray pyrolysis [16]

Epitaxial thin films of cobalt oxide were grown by atomic layer deposition (ALD) using $\text{Co}(\text{thd})_2$ (thd = 2,2,6,6-tetramethyl-3,5-heptanedionato) and ozone as precursors on single-crystalline $\text{MgO}(100)$, $\alpha\text{-Al}_2\text{O}_3(001)$, and $\text{SrTiO}_3(100)$ in the temperature range of 138–283 °C [17]. On $\text{MgO}(001)$ and/or SiO_2/Si substrates, the Co_3O_4 have also been grown by ALD in the substrate temperature range of 450-700 °C from CoI_2 and O_2 as precursors [18]. Into high aspect ratio substrates Co_3O_4 films have been grown by ALD from bis(cyclopentadienyl)cobalt(II), CoCp_2 , and ozone in the temperature range of 137-331 °C [19, 20]. In other ALD processes, $\text{Co}(\text{Cp})_2$ was used with ozone probably at 210 °C [21] or with O_2 plasma in the range of 100-400 °C [22]. Co_3O_4 films have later been grown at 120–300 °C using bis(1,4-di-iso-propyl-1,4-diazabutadiene)cobalt [$\text{C}_{16}\text{H}_{32}\text{N}_4\text{Co}$, $\text{Co}(\text{dpdab})_2$], and ozone in ALD on SiO_2 powder pellets [23], and in the range of 50-150 °C from cyclopentadienylcobalt dicarbonyl [$(\text{C}_5\text{H}_5)\text{Co}(\text{CO})_2$, $\text{CpCo}(\text{CO})_2$] and ozone on soda lime glass [24]. Carbonyl-based precursors, however, tend to decompose at rather low temperatures around 200 °C. Alumina supported cobalt catalysts were prepared in an ALD process [7], with the cobalt(II)acetylacetonate, $\text{Co}(\text{acac})_2$, or cobalt(III)acetylacetonate, $\text{Co}(\text{acac})_3$, as precursors, and, after the precursor chemisorption on alumina powders, the acac-ligands were removed using air at 450 °C. $\text{Co}(\text{acac})_3$ and O_3 have also been used to dope TiO_2 films in order to tune their magnetization characteristics [25].

There are very few studies available reporting the growth and characterization of cobalt-doped zirconia. Cobalt-doped ZrO_2 films have earlier been prepared by spray pyrolysis [26], microwave-assisted combustion [27] or sol-gel synthesis [28]. In certain cases, tendency to saturatively magnetize, and narrow hysteresis behavior has been observed in cobalt-doped zirconia [27, 28].

This study was conducted to investigate the growth and structure of ZrO_2 and Co_3O_4 , when deposited on one-another. Resistive switching characteristics of $\text{ZrO}_2\text{-Co}_3\text{O}_4$ nanolaminates were studied to evaluate if such films could be of interest from the viewpoint of memristor technology. Also, measurements were carried out to determine the polarization characteristics of the samples in the presence of an external magnetic or electric field. The purpose of this was to explore the possibility of these films exhibiting multiferroic behavior.

Experimental details

The films studied in this work were grown in a low-pressure flow-type ALD reactor [29]. Tris(2,4-pentanedionato)cobalt, 99,9%, also known as $\text{Co}(\text{acac})_3$, supplied by Volatec, Ltd.,

and used as the cobalt precursor, was evaporated at 125 °C from an half-open glass boat inside the reactor. Zirconium precursor was 99,99% $ZrCl_4$, supplied by Aldrich. $ZrCl_4$ was evaporated at 162 °C from an half-open glass boat inside the reactor. Nitrogen, N_2 (99.999% purity, AGA), was applied as the carrier and purging gas. Ozone produced from O_2 (99.999% purity, AGA) was used as an oxidizer and the ALD reactions were carried out at 300 °C.

Two-layer nanolaminates of ZrO_2 and Co_3O_4 were deposited in a following manner: $100 \times ZrO_2$ (100 ALD growth cycles of ZrO_2) + $200 \times Co_3O_4$ (200 cycles of Co_3O_4). Alternatively, the order of layers was reversed from ZrO_2/Co_3O_4 to Co_3O_4/ZrO_2 . The cycle times for ZrO_2 were 5-5-5-5 s for the sequence $ZrCl_4$ pulse – N_2 purge – O_3 pulse – N_2 purge. Cycle times for an analogous Co_3O_4 growth cycle were 7-5-5-5 s.

Films were grown on various substrates: Si(100) cleansed and etched [30] and highly-doped conductive Si substrates covered by 10 nm thick TiN film grown by chemical vapor deposition. The films, which were deposited on TiN substrates for electrical measurements, were also supplied with platinum electrodes electron-beam evaporated on top of the films.

X-ray fluorescence (XRF) spectrometer Rigaku ZSX 400 and program ZSX Version 5.55 was used to measure the elemental composition of films. Spectroscopic ellipsometer (SE), model GES5-E, was used for the measurements of the films thicknesses. The crystal structure was evaluated by grazing incidence X-ray diffractometry (GIXRD), using a X-ray diffractometer SmartLab Rigaku with $CuK\alpha$ radiation, which corresponds to an X-ray wavelength of 0.15406 nm. Surface morphology of films was evaluated by scanning electron microscopy (SEM) using a Dual Beam equipment FEI Helios NanoLab 600.

Ferroelectricity measurements were done by means of an Agilent DXO-X 3104 digital oscilloscope with a built-in wave generator. The standard Sawyer-Tower experiment was carried out by applying a periodic triangular-shaped stimulus and recording the voltage loops data from the oscilloscope. Charge values were obtained from the sensed voltage across a stated capacitance.

Resistive switching measurements were carried out by means of a semiconductor analyzer Keithley 4200SCS, with samples put in a light-tight and electrically shielded box. The DC voltage was applied to the top electrode, leaving the bottom one grounded.

Magnetic measurements were performed using Vibrating Sample Magnetometer (VSM) option of the Physical Property Measurement System 14T Quantum Design by scanning the magnetic field from -1 to 1 T parallel to the film surface at room temperature.

Results and discussion

Film growth and composition

ALD reactions were carried out at 300 °C, since reactions for Co_3O_4 at 250 °C and 350 °C resulted in growth per cycle, which was 50% and 60% lower than for samples deposited at 300 °C, respectively. ZrO_2 also exhibited the highest growth rate at 300 °C. Evaporator temperature for $\text{Co}(\text{acac})_3$ was chosen to be 125 °C, since the deposited amount of cobalt did not increase upon further increasing the temperature (Fig. 1). Co_3O_4 deposition consisting of 200 or more ALD cycles resulted in similar growth rates. For a lower amount of ALD cycles, the growth rate to number of cycles is not a linear relationship (Fig. 2). Thickness and composition data is given in Table I. Nanolaminate films were deposited in such a manner that the layers were similar in terms of their thickness.

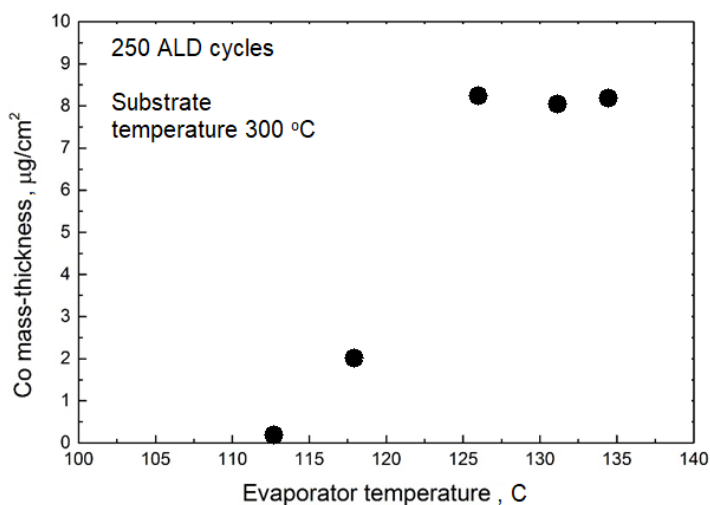


Fig. 1. Mass-thickness of cobalt with respect to evaporator temperature. Each deposition consisted of 250 ALD cycles at 300 °C. The dot diameter covers the error estimation.

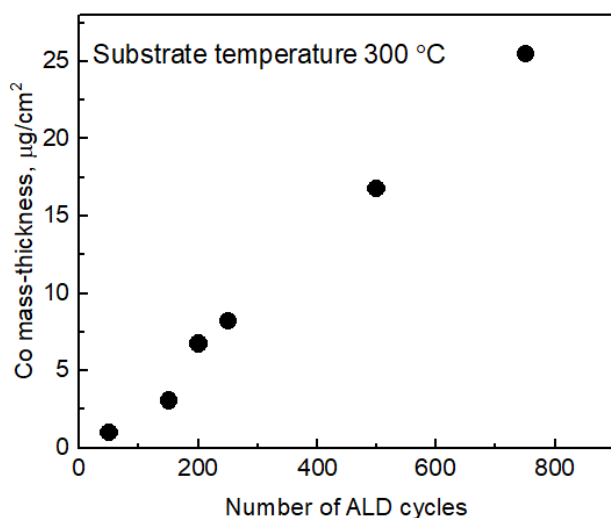


Fig. 2. Mass-thickness of cobalt per cycle with respect to number of ALD cycles. The dot diameter covers the error estimation.

Table I. Thickness and composition data of the samples. d – thickness, GPC – growth per cycle.

	d, nm	d(ZrO ₂), nm	d(Co ₃ O ₄), nm	Cation ratio, Zr/Co	Cl, wt. %	C, wt. %	GPC (ZrO ₂), nm	GPC (Co ₃ O ₄), nm
ZrO ₂	31	31	-	-	0.4	-	0.13	-
Co ₃ O ₄	15	-	15	-	-	7.8	-	0.06
ZrO ₂ /Co ₃ O ₄	24	12	12	0.7	0.3	5.3	0.12	0.06
Co ₃ O ₄ /ZrO ₂	26	14	12	1.2	0.5	3.3	0.14	0.06

Film structure

GIXRD shows that the films were crystalline, as deposited. The cubic phase of ZrO₂ (PDF Card 00-027-0997) is dominant, also some peaks could be assignable to the tetragonal phase, but in the case of given analysis here, such a distinction can not be made with certainty. Small peaks of the monoclinic ZrO₂ (PDF Card 00-037-1484) are also detectable in the case of pure ZrO₂. Only the cubic phase of Co₃O₄ (PDF Card 00-042-1467) can be seen. The nanolaminates exhibit the peaks of both cubic ZrO₂ and cubic Co₃O₄, although the peaks are

significantly less intense. This is most likely due to the thickness of nanolaminate layers which is lower than that of the reference single metal oxides (Fig. 3).

Scanning electron microscope images of the film surfaces indicate that, regardless of rather low layer thicknesses, all films are continuous over the surface, without holes or pores visible on the surface and crystallization is also evident (Fig. 4). Co_3O_4 film shown on figure 4.a was deposited using 200 ALD deposition cycles. On figure 4.b, a Co_3O_4 film is shown, which is deposited with 50 cycles and it can be seen that such a film may not even be continuous, therefore limiting the minimum thickness to which a continuous Co_3O_4 film can be deposited.

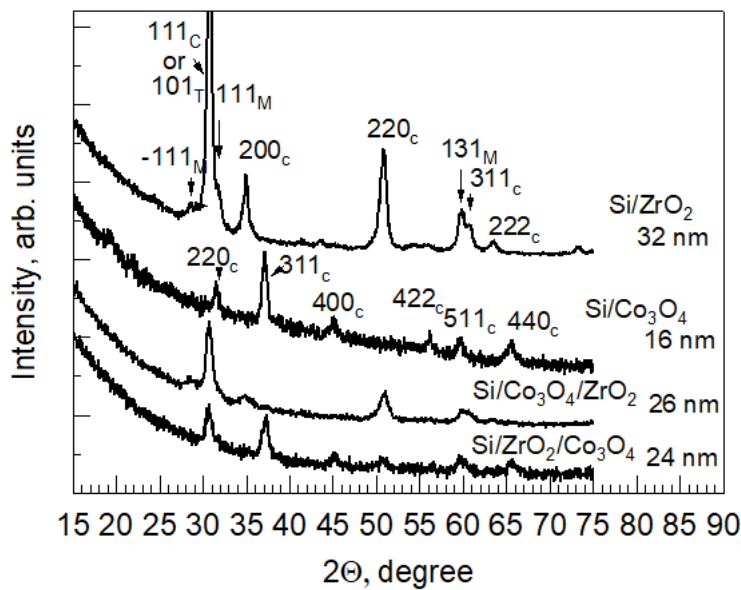


Fig. 3. GIXRD diffractograms for pure ZrO_2 , Co_3O_4 and two-layer nanolaminates $\text{Co}_3\text{O}_4/\text{ZrO}_2$ and $\text{ZrO}_2/\text{Co}_3\text{O}_4$. The composition and thicknesses of the layers are indicated by the labels at the patterns. Miller indices are attributed to corresponding monoclinic (M) and cubic (C) phases.

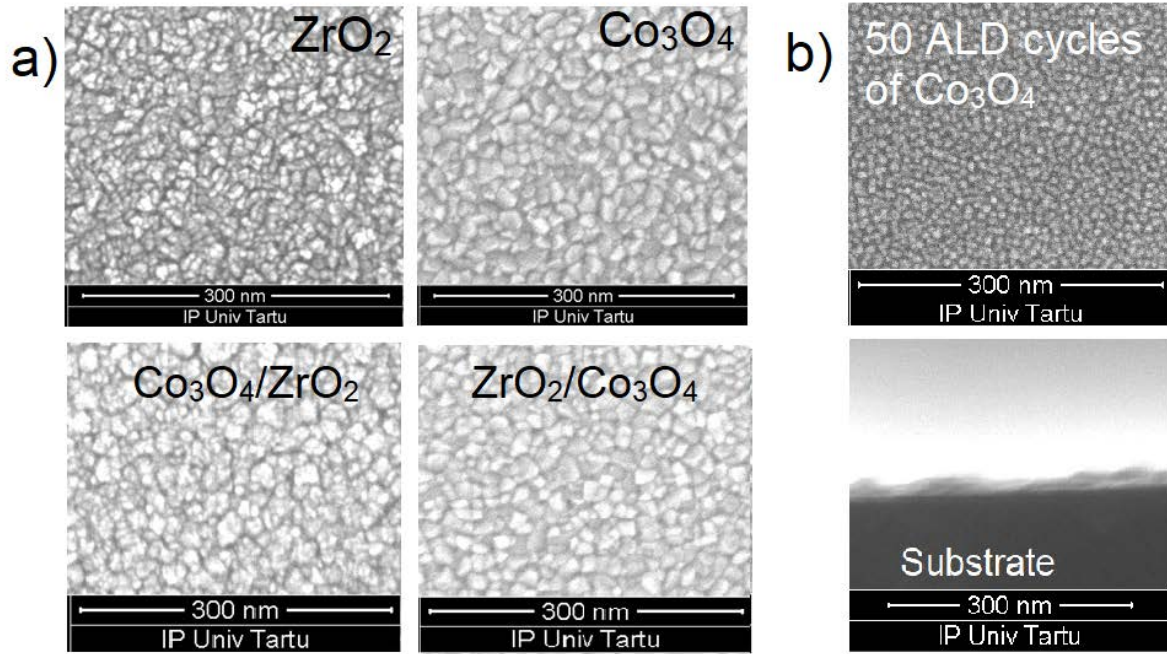


Fig. 4. a) Scanning electron microscope images of zirconium and cobalt oxides in the upper row and nanolaminates with a structure of $\text{Co}_3\text{O}_4/\text{ZrO}_2$ and $\text{ZrO}_2/\text{Co}_3\text{O}_4$, in left and right panels, respectively, in the lower row. b) 50 ALD cycles of Co_3O_4 surface on top panel and sideview of the same sample on the bottom panel.

Electrical and magnetic properties

Figure 5 depicts current-voltage curves from the films described in Table I, measured in resistive switching regime. It can be observed that all samples show bipolar behavior, but with opposite signs (Fig. 5). More specifically, in the films of pure Co_3O_4 and $\text{ZrO}_2/\text{Co}_3\text{O}_4$ the transition from high to low resistance state (SET) occurs at negative voltages, whereas the transition from high to low resistance state (RESET) occurs at positive voltages. On the other hand, in the samples of pure ZrO_2 and $\text{Co}_3\text{O}_4/\text{ZrO}_2$ SET occurs at positive voltages (Fig. 5). Polarity is expressed as that of Pt dot electrode in relation to TiN/Si.

In both types of nanolaminates, SET is gradual, whereas RESET is very sharp (when RESET occurs, the currents drop sharply). The opposite sign of the bipolar loops can be related to the ordering of the bilayer. The conductive filaments in such materials are formed due to the accumulation of oxygen vacancies, which cluster, thus connecting top and bottom electrodes (SET process). Oxygen vacancies are due to the migration of negative oxygen ions from the dielectric film. RESET process is essentially the opposite mechanism: oxygen anions are

moved from the metal to the insulator and backfill the vacancies to annihilate the conductive path [31, 32].

Therefore, negative reset voltage values indicate that oxygen atoms coming from the top electrode causes the conductive filament oxidation in the adjacent insulator, that is, in the upper dielectric region. That is the case of sample $\text{Co}_3\text{O}_4/\text{ZrO}_2$. In sample $\text{ZrO}_2/\text{Co}_3\text{O}_4$, reset occurs for positive voltages, i.e., due to oxygen ions coming from the bottom electrode to the bottom dielectric region (ZrO_2 as well). In summary, filaments are broken and refilled at the ZrO_2 film (the free energy oxidation energy is more negative for ZrO_2 than for Co_3O_4). The resistance ratio of the high- and low- resistance states was 35 for the $\text{Co}_3\text{O}_4/\text{ZrO}_2$ film. For other films this ratio was 3-4. Resistance states were compared at a voltage of 0.5 V.

All samples exhibited certain charge polarization, as shown in Figure 6. Although in the case of pure ZrO_2 , the charge polarization values were insignificant, compared to other samples. Charge polarization was about 1 nC at 0 V, for ZrO_2 . With no applied voltage, the Co_3O_4 sample exhibited a charge polarization value of $1.5 \cdot 10^5$ nC, and $4.0 \cdot 10^4$ nC for the nanolaminates. The charge polarization – applied voltage loops observed here are not quite attributable to ferroelectric behavior. Even if ferroelectric effect is contributing, it is overwhelmed by other effects, such as interfacial polarization. Saturation level for charge polarization was not achieved at either polarity of the external field, as the polarized charge kept increasing with the voltage. An argument on behalf of leakage current being responsible for the charge polarization has been given by Kalam, et al [30] in the case of iron oxide doped ZrO_2 . According to Scott [33], such charge polarization to voltage curves could not be attributed to ferroelectricity. For comparison to literature data, Lin *et al.* [34] has demonstrated charge-field loops from orthorhombic ZrO_2 grown by plasma-assisted ALD between Pt electrodes, resembling those characteristic of a ferroelectric material.

All samples were magnetized in the presence of an external magnetic field and exhibited fast nonlinear saturative magnetization, which is generally characteristic of a ferromagnetic material. Coercivity values of films were low, ranging from 20-150 Oe, resulting in very narrow hysteresis loops. Saturation magnetization values ranged from $1 \cdot 10^{-6}$ emu to $4 \cdot 10^{-6}$ emu (Fig. 7).

Relative permittivity of pure ZrO_2 film in this work is 26 (Fig. 8). Zhao and Vanderbilt [35] have shown that cubic ZrO_2 has an averaged relative permittivity of 36.8 and monoclinic 19.7. Assuming all of our film to be crystalline and exhibit only cubic and monoclinic phases, this

should imply that our film consists of 63% monoclinic and 37% cubic phase. Since the GIXRD analysis shows mostly cubic, possibly tetragonal and very little monoclinic phase, we can only assume that the film is not fully crystalline, but somewhat amorphous with regions of mostly cubic crystal lattice. In the case of pure Co_3O_4 the experimentally measured permittivity value is slightly higher at low frequency (approximately 30) and diminishes as frequency increases. Nanolaminates exhibited higher permittivity values than each of the pure oxide films separately (Fig. 8). This is possibly due to a larger portion of the films being crystalline. On the other hand, the space charge region created at the interface between both oxide layers has as final effect the reduction of the effective insulator thickness, dealing an apparent reduction of the permittivity. Besides, samples containing Co_3O_4 exhibit a more significant variation of the permittivity with the frequency. This seems indicate that the dipolar relaxation of Co_3O_4 is greater than that of ZrO_2 .

Refractive index values and dispersion are given on figure 9. Garcia *et al.* [36] have found the refractive index of Co_3O_4 to be 2.48 at 633 nm. This is very similar to our result, however comparing the shape of dispersion function is not possible, since they have only reported the refractive index at a certain wavelength. Al-Maiyaly [37], Ekwealor et al. [38] and Gençyılmaz *et al.* [39] have reported similar refractive index values for Co_3O_4 and also similar shapes of the dispersion functions as are shown on figure 9.

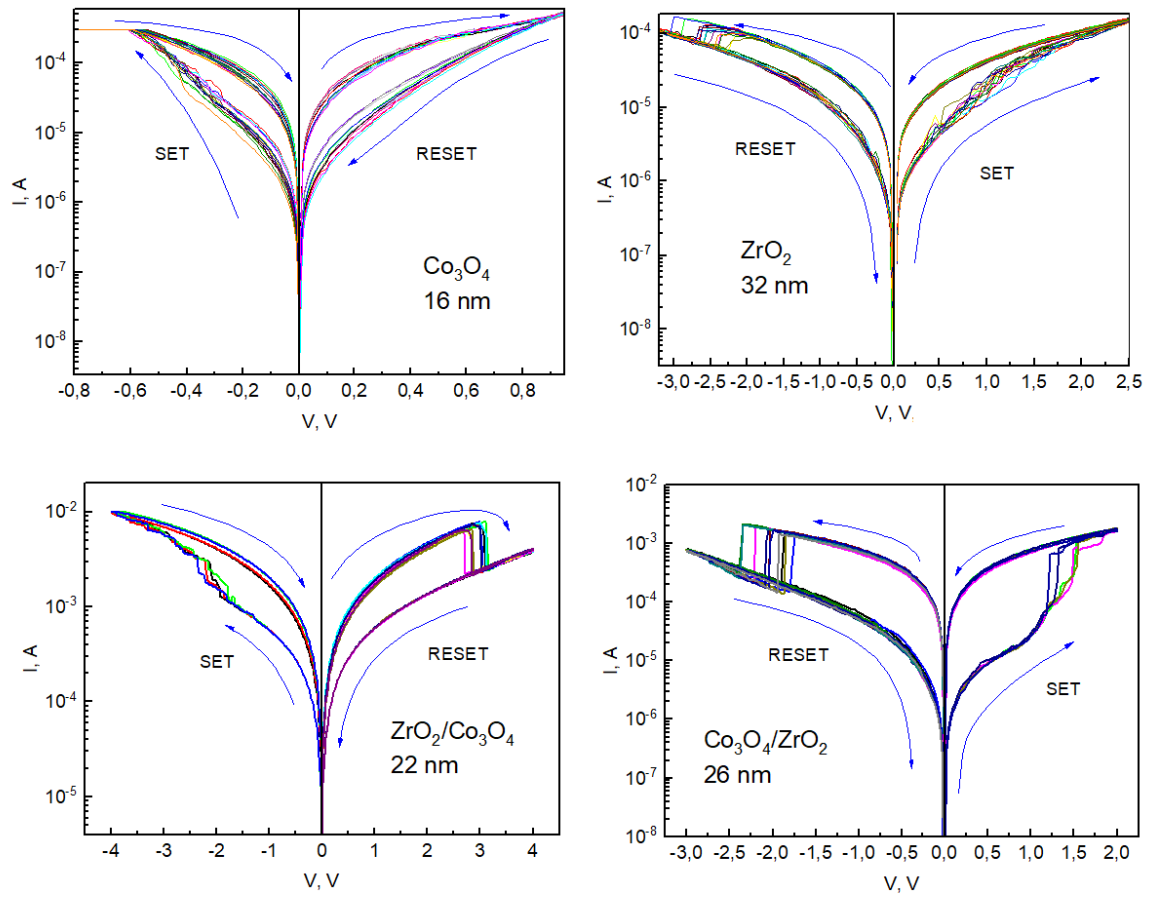


Fig. 5. Resistive switching cycles for metal oxides described by Table I. The composition and thickness of the metal oxide layers are indicated by labels.

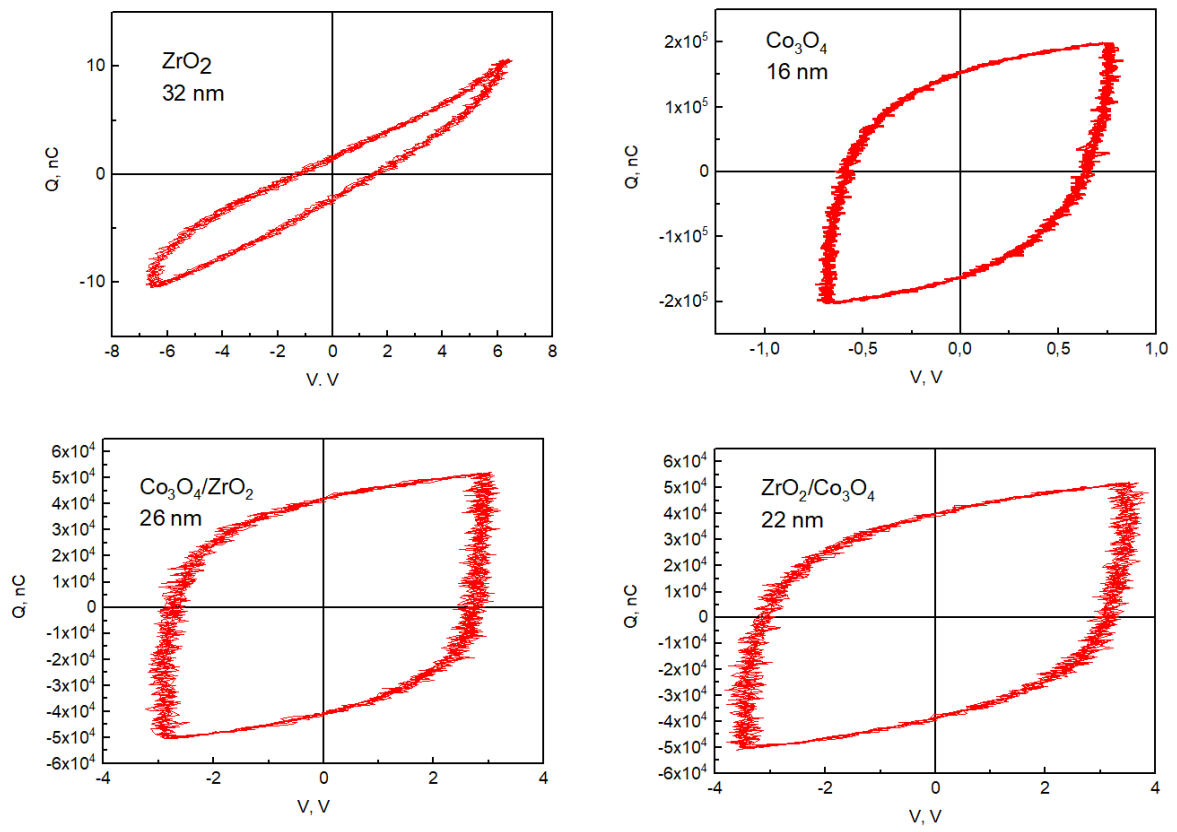


Fig. 6. Charge polarization *versus* applied voltage curves. The composition and thickness of the metal oxide layers are indicated by labels.

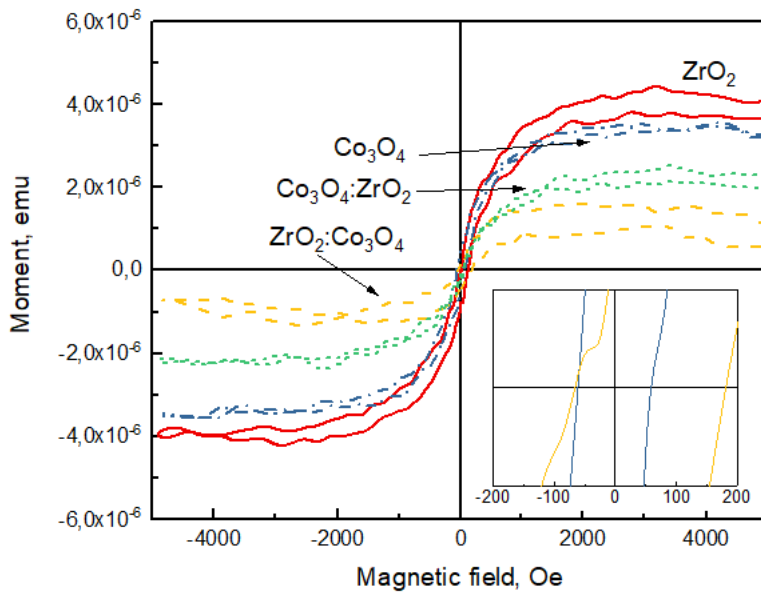
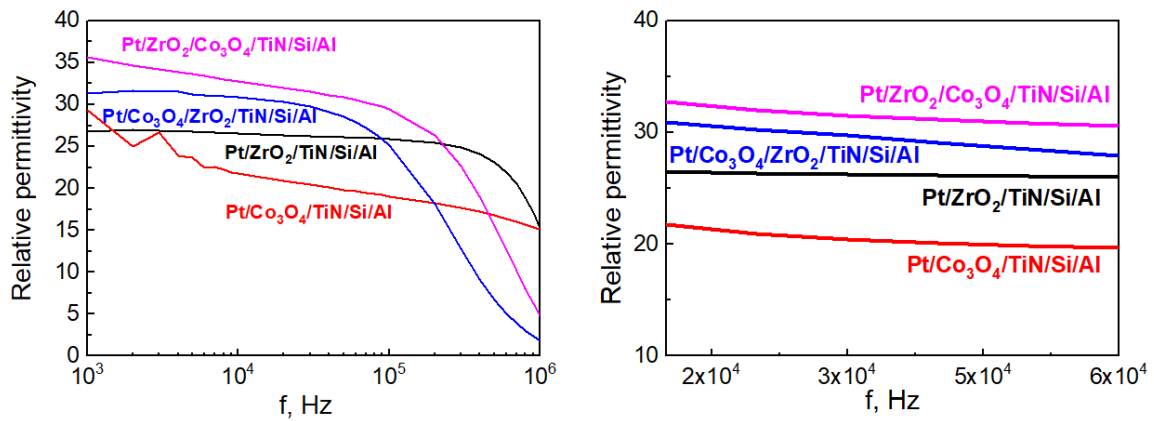


Fig. 7. Magnetization to applied magnetic field curves measured at room temperature for metal oxides described by Table I. Panel in the lower right corner shows the coercivity values



for two samples at a larger scale.

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Fig. 8. Relative permittivity curves measured for metal oxides described by Table I. The composition of the functional layers, as well as the electrodes and the substrate, are indicated by labels.

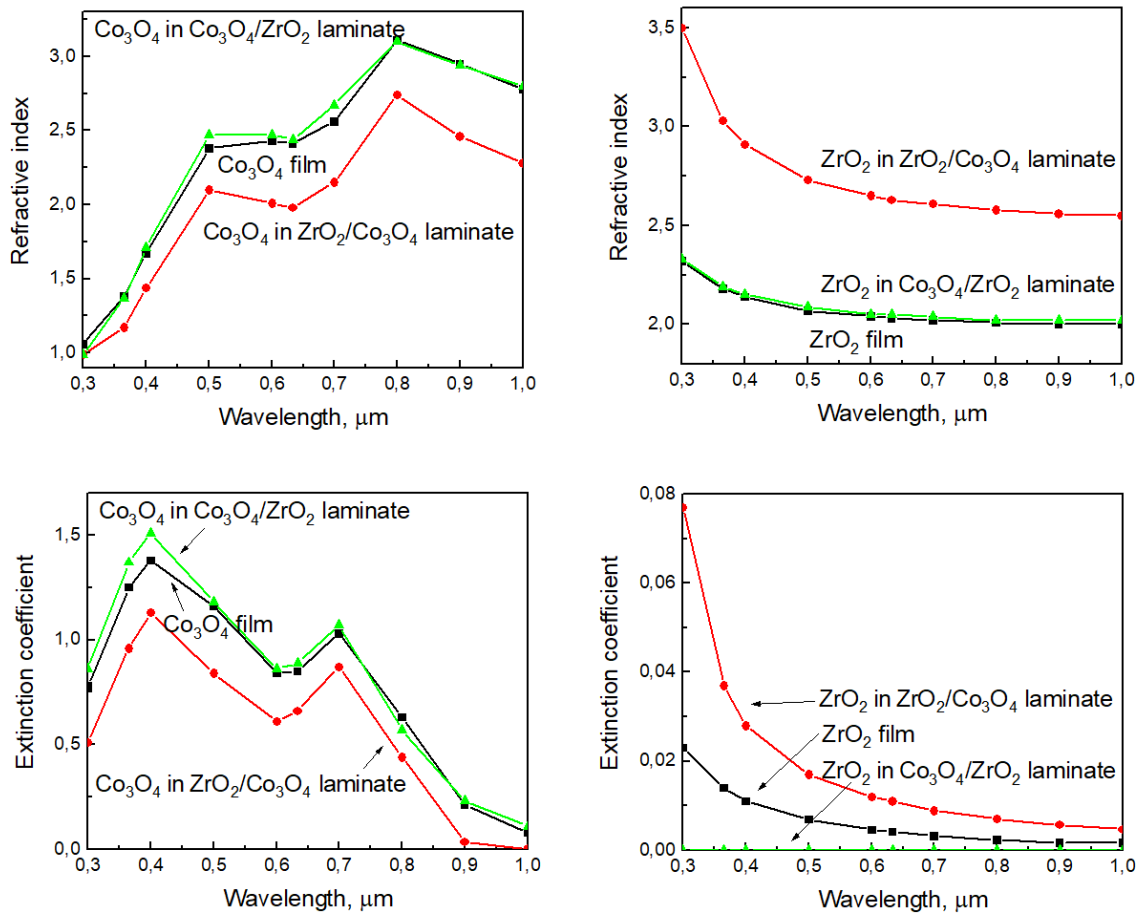


Fig. 9. Dispersion of Co_3O_4 on the left panels and ZrO_2 on the right panels. Top panels show the dispersion of refractive index, bottom panels show the dispersion of extinction coefficient.

Summary

$\text{ZrO}_2\text{-Co}_3\text{O}_4$ nanolaminates were deposited by ALD, using ZrCl_4 , $\text{Co}(\text{acac})_3$ and O_3 . All films exhibited room-temperature saturation magnetization, charge polarization and resistive switching characteristics to some extent, in their as-deposited state. Values for saturation magnetization ranged from $1 \cdot 10^{-6}$ to $4 \cdot 10^{-6}$ emu. Charge polarization values at 0 V were $4.0 \cdot 10^4$ nC for the nanolaminates and the resistance ratio of the high- and low- resistance states was 35 for the $\text{Co}_3\text{O}_4/\text{ZrO}_2$ film. Relative permittivity and dispersion functions for the studied films were also presented.

Acknowledgements

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